SCAS081A - NOVEMBER 1989 - REVISED APRIL 1996

- Center-Pin V_{CC} and GND Configurations **Minimize High-Speed Switching Noise**
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at
- **Package Options Include Plastic** Small-Outline (D) Packages and Standard Plastic 300-mil DIPs (N)

D OR N PACKAGE (TOP VIEW) ∏ 1B 1A 1Y [15 **∏** 2A 2 2Y 🛮 3 14 🛮 2B 13 V_{CC} GND [GND [12 V_{CC} 3Y 🛮 11 3A 10 🛮 3B 4Y 4B П 4А 8 9

description

This device contains four independent 2-input exclusive-OR gates. It performs the Boolean function $Y = A \oplus B = \overline{A}B + A\overline{B}$ in positive logic.

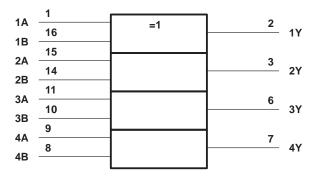
A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

The 74AC11086 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each gate)

INP	UTS	OUTPUT
Α	В	Υ
L	L	L
L	Н	Н
Н	L	Н
Н	Н	L

logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.



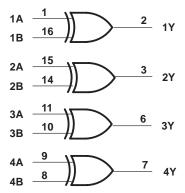
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logic diagram (positive logic)



exclusive-OR logic

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.

EXCLUSIVE OR



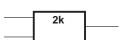
These are five equivalent exclusive-OR symbols valid for a 74AC11086 gate in positive logic; negation may be shown at any two ports.

LOGIC-IDENTITY ELEMENT



The output is active (high) if all inputs stand at the same logic level (i.e., A=B).

EVEN-PARITY ELEMENT



The output is active (high) if an even number of inputs (i.e., 0 or 2) are active (high).

ODD-PARITY ELEMENT



The output is active (high) if an odd number of inputs (i.e., only 1 of the 2) are active (high).

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	0.5 V to 7 V
Input voltage range, V _I (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	
Continuous current through V _{CC} or GND	
Maximum power dissipation at $T_A = 55^{\circ}$ C (in still air) (see Note 2): D package	
N package	1.1 W
Storage temperature range, T _{sto}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils, except for the N package, which has a trace length of zero.



recommended operating conditions

			MIN	NOM	MAX	UNIT
Vcc	Supply voltage		3	5	5.5	V
		V _{CC} = 3 V	2.1			
ViH	High-level input voltage	V _{CC} = 4.5 V	3.15			V
		$V_{CC} = 5.5 V$	3.85			
		VCC = 3 V			0.9	
VIL	Low-level input voltage	$V_{CC} = 4.5 \text{ V}$			1.35	V
		V _{CC} = 5.5 V	1.65			
٧ı	Input voltage		0		VCC	V
٧o	Output voltage		0		VCC	V
		V _{CC} = 3 V	-4			
IOH	High-level output current	V _{CC} = 4.5 V			-24	mA
		V _{CC} = 5.5 V			-24	
		V _{CC} = 3 V			12	
lOL	Low-level output current	V _{CC} = 4.5 V			24	mA
		$V_{CC} = 5.5 V$			24	
Δt/Δν	Input transition rise or fall rate		0		10	ns/V
TA	Operating free-air temperature		-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST COMPLIANCE	V	T _A = 25°C			TAUN!	MAY	LINUT	
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	UNIT	
		3 V	2.9			2.9			
	$I_{OH} = -50 \mu\text{A}$	4.5 V	4.4			4.4			
		5.5 V	5.4			5.4			
Voн	$I_{OH} = -4 \text{ mA}$	3 V	2.58			2.48		V	
		4.5 V	3.94			3.8			
	$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.8			
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85			
		3 V			0.1		0.1		
	I _{OL} = 50 μA	4.5 V			0.1		0.1		
		5.5 V			0.1		0.1		
VOL	I _{OL} = 12 mA	3 V			0.36		0.44	V	
	Jan. 24 mA	4.5 V			0.36		0.44		
	I _{OL} = 24 mA	5.5 V			0.36		0.44		
	I _{OL} = 75 mA [†]	5.5 V					1.65	1	
lį	V _I = V _{CC} or GND	5.5 V			±0.1		±1	μΑ	
lcc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40	μΑ	
Ci	V _I = V _{CC} or GND	5 V		3.5				pF	

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то		4 = 25°C	;	MIN	MAX	UNIT
FARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	IVIAA	ONIT
t _{PLH}	A or B	V	1.5	5.6	9.4	1.5	10.6	20
t _{PHL}	AUID	ī	1.5	5.1	7.4	1.5	8.2	ns

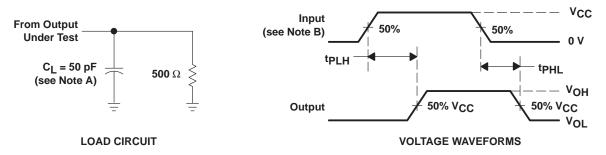
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T,	4 = 25°C	;	MIN	MAX	UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	IVIIIV	WAX	UNIT
t _{PLH}	A or B	V	1.5	3.8	6.8	1.5	7.6	no
t _{PHL}	AUID	ī	1.5	3.8	6.2	1.5	6.8	ns

operating characteristics, V_{CC} = 5 V, T_A = 25°C

		PARAMETER	TEST CON	TYP	UNIT	
ſ	C _{pd}	Power dissipation capacitance per gate	C _L = 50 pF,	f = 1 MHz	27	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \ \Omega$, $t_f = 3 \ ns$, $t_f = 3 \ ns$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

10-Dec-2020

PACKAGING INFORMATION

www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
74AC11086D	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AC11086	Samples
74AC11086N	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	-40 to 85	74AC11086N	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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10-Dec-2020

PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
74AC11086D	D	SOIC	16	40	507	8	3940	4.32
74AC11086N	N	PDIP	16	25	506	13.97	11230	4.32
74AC11086N	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDS0-G16)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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